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卓荣集成

# CW6676H

**Bluetooth Headphone Microcontroller**

**Product Spec**

[CW6676H-PS-EN]

Versions: 1.0.0

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# 1 Product Overview

## 1.1 Outline

CW6676H is an MCS-51<sup>TM</sup> Compatible high performance mixed signal microcontroller. It integrates advanced digital and analog peripherals to suit for BT headphone applications.

## 1.2 Features

- CPU Compatible with MCS-51<sup>TM</sup> instruction set;
- Compliant to Bluetooth 4.2 + EDR, backward-compatible with BT1.2, 2.0 and 2.1
- Support SCMS-T content protection method;
- Support HFP v1.6, HSP v1.2, A2DP 1.3, AVCTP 1.4, AVDTP 1.3 and AVRCP 1.5
- Class 2 power level, RF Performance: Tx:0dBm, Rx: -80dBm;
- Support simple pairing and auto reconnection function;
- Six Channels 10-bit SARADC;
- support 16bit Stereo DAC with >90dB SNR, embedded with two class A/B headphone amplifier
- 16bit Mono ADC with >90dB DR
- Support Audio record function to MIC ADPCM;
- Two 8-bit timers, support Capture and PWM mode;
- Two 16-bit timers, support Capture and PWM mode;
- Watchdog Timer with on-chip RC oscillator;
- Support full-duplex IIS, UART, SPI interface;
- 2 channels 16 levels Low Voltage Detector;
- Power on Reset
- Support Full speed USB 2.0 PHY;
- Full speed USB 2.0 HOST/DEVICE controller;
- Internal crystal oscillator support 26M crystal
- Internal LDO regulator:1.35V to 1.2V;4.2V to 3.3V
- Built-in buck converter,DC-DC:4.2V to 1.35V

## 2 Pin Definitions

### 2.1 CW6676H

#### 2.1.1 Package

LQFP48

#### 2.1.2 Pin Assignment

Figure 2-1 shows the pin assignments of LQFP48 package.

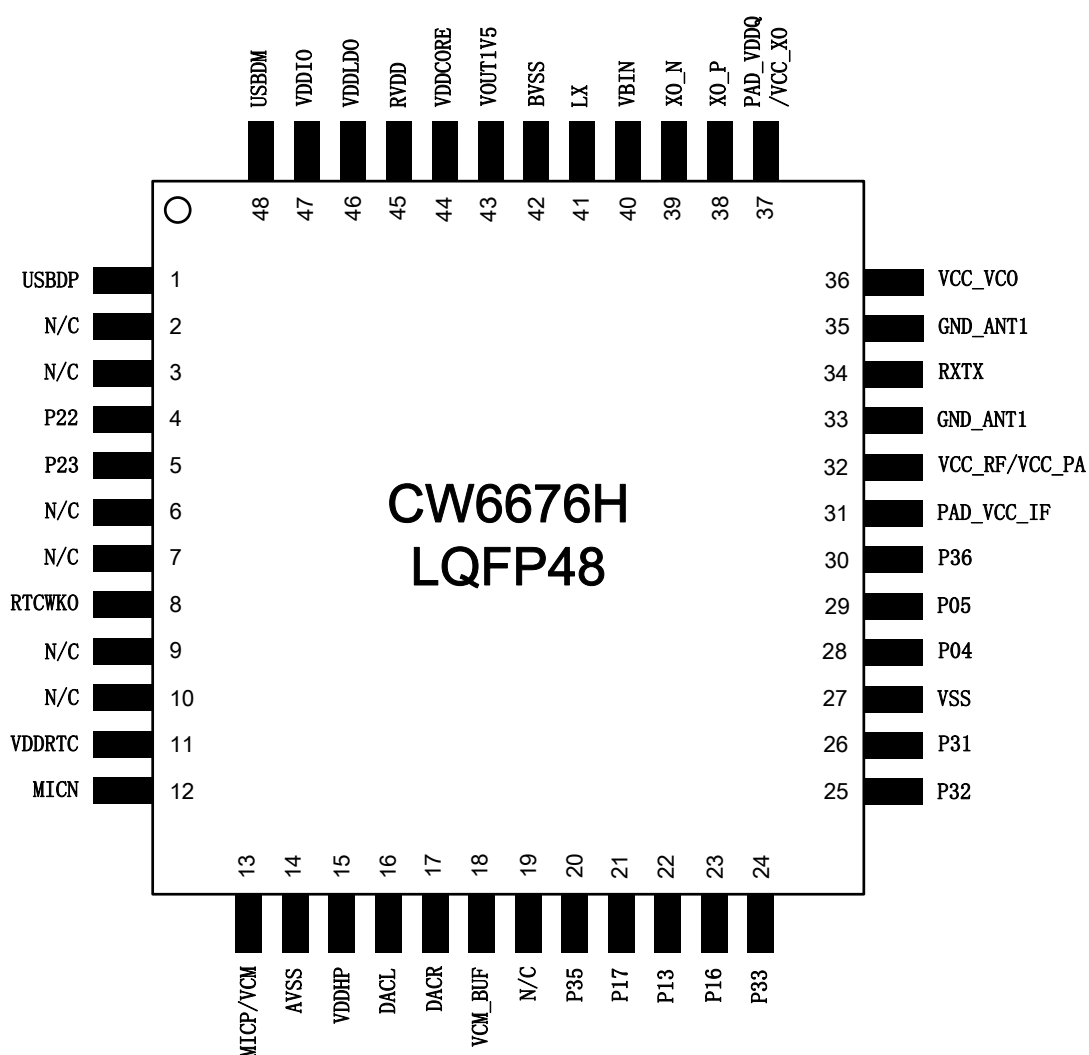


Figure 2-1 Pin Assignment of CW6676H

## 2.1.3 Pin Description

*Table 2-1* shows the pin description of CW6676H.

Table 2-1 Pin Description of CW6676H

Pin No.LQFP48	Name	Type	Function
1	USBDP	I/O	USB Positive Input/output
2	N/C	N/C	N/C
3	N/C	N/C	N/C
4	P22	I/O	GPIO ADC3 EMIDAT2 IISDO1 LCD_D2
5	P23	I/O	GPIO EMIDAT3 IISDI1 LCD_D3
6	N/C	N/C	N/C
7	N/C	N/C	N/C
8	RTCWKO	I/O	RTC wakeup
9	N/C	N/C	N/C
10	N/C	N/C	N/C
11	VDDRTC	PWR	RTC power input
12	MICN	A	MIC Negative input
13	MICP/VCM	A	MIC Positive input DAC VCM output
14	AVSS	GND	Analog GND
15	VDDHP	PWR	Headphone power
16	DACL	A	DAC left output GPIO input
17	DACR	A	DAC right output GPIO input
18	P01/VCM_BUF	I/O	GPIO AUXR0 UARTTX1 PORTINT/WKUP0 DAC VCM buffer
19	N/C	N/C	N/C
20	N/C	N/C	N/C
21	P17	I/O	GPIO BT UART1RX TMR2CKI

Pin No.LQFP48	Name	Type	Function
			IISWS0
22	P13	I/O	GPIO ADC5 IISBCLK0
23	N/C	N/C	N/C
24	N/C	N/C	N/C
25	P32	I/O	GPIO SDDAT0 SPI0DOUT3/DIN3
26	P31	I/O	GPIO SDCMD SPI0DIN3
27	VSS	GND	GND
28	P04	I/O	GPIO SPI1DOUT/DIN1
29	P05	I/O	GPIO SPI1CLK
30	P36	I/O	GPIO
31	PAD_VCC_IF	PWR	Power VCC
32	VCC_RF/VCC_PA	PWR	RF/PA Power VCC
33	GND_ANT1	GND	FR GND
34	RXTX	A	RF Rx and Tx pin
35	GND_ANT1	GND	RF GND
36	VCC_VCO	PWR	Power VCC
37	VCC_XO/ PAD_VDDQ	PWR	Power VCC/VDDQ
38	XO_P	A	BT 26MHz XOSC Positive Pin
39	XO_N	A	BT 26MHz XOSC Negative Pin
40	BVIN	PWR	PMU Power input Pin 4.2V(typ)
41	LX	A	Switch Node Connection to Inductor
42	BVSS	GND	GND
43	VOUT1V5	PWR	VOUT 1.5V
44	VDDCORE	PWR	Core power VDD 1.2V
45	RVDD	PWR	RF power VDD
46	VDDLDO	PWR	LDO power input 4.2V(typ)
47	VDDIO	PWR	Power output VDDIO 3.3V
48	USBDM	I/O	USB Negative Input/output

## 3 Characteristics

### 3.1 PMU Parameters

Table 3-1 PMU Parameters

Sym	Characteristics	Min	Typ	Max	Unit	Conditions
BVIN	Buck input voltage	2.8	4.2	4.6	V	
VDDLDO	VDDLDO input voltage	2.8	4.2	4.6	V	
VOUT1V5	Buck output voltage	1.15	1.35	1.6	V	
VDDCORE	1.2V output voltage	-	1.2	-	V	
VDDRTC	input voltage	2.2	4.2	4.6	V	
VDDHP	3.0V output voltage	2.8	3.0	3.3	V	
VCM	1.5V output voltage	-	1.35	-	V	
RVDD	output voltage	1.1	1.2	1.3	V	
VDDIO	3.3V output voltage	2.8	3.3	-	V	

### 3.2 CORE PLL Parameters

Table 3-2 PLL Parameters

Sym	Characteristics	Min	Typ	Max	Unit	Conditions
F <sub>I1</sub>	Frequency input	-	32.768	-	KHz	Low frequency OSC
F <sub>I2</sub>	Frequency input	1	12	15	MHz	High frequency OSC
F <sub>OUT1</sub>	Frequency output	-	48	-	MHz	
T <sub>LOCK1</sub>	PLL locked time	-	2	-	ms	Use low frequency OSC as input reference
T <sub>LOCK2</sub>	PLL locked time	-	0.1	-	ms	Use high frequency OSC as input reference

### 3.3 General purpose I/O Parameters

Table 3-3 I/O Parameters

Symbol	Description	Min	Typ	Max	Units	Conditions
V <sub>IL</sub>	Low-Level input voltage	-	-	30% * VDDIO	V	VDDIO = 3.3V
V <sub>IH</sub>	High-level input voltage	70% * VDDIO	-	-	V	VDDIO = 3.3V
R <sub>PUP0</sub>	Internal pull-up resistor 0	-	10	-	KΩ	
R <sub>PUP1</sub>	Internal pull-up resistor 1	-	200	-	KΩ	
R <sub>PUP2</sub>	Internal pull-up resistor 2	-	0.5	-	KΩ	
R <sub>PDN0</sub>	Internal pull-down resistor 0	-	10	-	KΩ	
R <sub>PDN1</sub>	Internal pull-down resistor 1	-	0.33	-	KΩ	
R <sub>PDN2</sub>	Internal pull-down resistor 2	-	0.5	-	KΩ	
I <sub>LEVEL1</sub>	Level1 current driving	8	-	-	mA	For PORT1

Symbol	Description	Min	Typ	Max	Units	Conditions
I <sub>LEVEL2</sub>	Level2 current driving	24	-	-	mA	For Port1.1

## 3.4 Audio ADDA Parameters

Table 3-4 Audio DAC Parameters

Sym	Characteristics	Min	Typ	Max	Unit	Conditions
DAC SNR&DR		-	90	-	dB	48PIN
DAC SNR&DR		-	90	-	dB	28PIN & 20 PIN
DAC THD+N		-	-80	-	dB	10Kohm loading
PWR <sub>AB</sub>	ClassAB AMP power output	-	-	16	mW	32ohm loading
V <sub>PP</sub>	Maximum output voltage	-	-	2.6	V	10Kohm loading
ADC SNR/DR			93		dB	In Voice Band
ADC THD+N			89		dB	In Voice Band

## 3.5 RF Analog Blocks

Table 3-5 Frequency Synthesizer Parameters

Parameter	Condition		MIN	typ	max	Unit
Synthesizer						
Synthesizer settling time	Within +/- 25 KHz accuracy		-	70	-	us
Phase Noise	Fc=2.4GHz	$\Delta F=1$ MHz	-	-110	-	dBc/Hz
		$\Delta F=2$ MHz	-	-118	-	dBc/Hz
		$\Delta F\geq 3$ MHz	-	-123	-	dBc/Hz
XTAL Oscillator						
Frequency range			-	26	-	MHz
Frequency Trimming Range	6 bits		-1	-	+1	kHz

Table 3-6 Receive path Parameters

Parameter	Condition	MIN	typ	max	Unit
Receiver Channel					
Minimum Usable Signal	RX sensitivity	-	-80	-	dBm
LNA					
Gain	High Gain	-	25	-	dB
	Mid Gain	-	15	-	dB
	Low Gain	-	5	-	dB
Mixer					
Conversion Gain		-	0	-	dB
IFamp					
Gain	5/9/12/15/18 dB	-	12	-	



Parameter	Condition	MIN	typ	max	Unit
Complex BPF					
Band pass -3 dB BW	Figure 1.	-	2	-	MHz
Image Rejection		-	30	-	dB
VGA					
Gain Range		-6	-	+68	dB
Gain Step		-	+1/+6	-	dB
ADMOD					
SNDR	Freq = +- BW	-	>50	-	dB

Table 3-7 Transmit path Parameters

Parameter	Condition	MIN	typ	max	Unit	
Transmit Channel						
Available output power		-2	0	1.5	dBm	
Side Band Suppression		-	-30	-	dBm	
LPF						
Low pass -3 dB BW	Figure 2.	-	1	-	MHz	
TXVGA						
Gain Step		-7	-	7	dB	
PA						
Gain Range	Set paPWR[2:0] of	GFSK	-12	-	4	dBm
	Control Register #16	DPSK	-15	-	1	dBm

## 4 Package Outline Dimensions

### 4.1 LQFP48

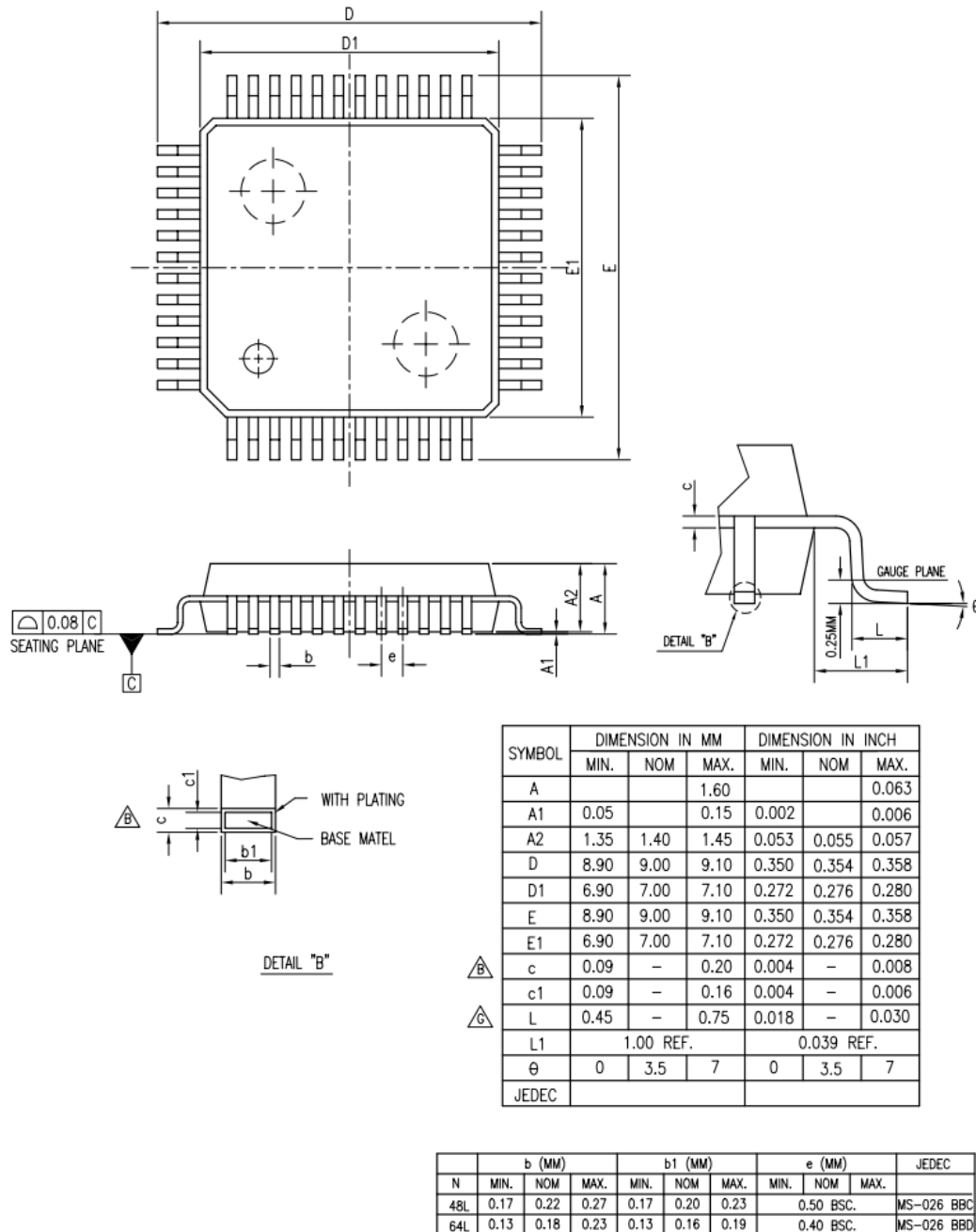


Figure 4-1 LQFP48 Package Outline Dimension

## Revision History

Date	Version	Comments	Revised by
2016/9/23	0.0.1	Initial version	YX
2016/9/23	1.0.0	Release	YX